

Title (en)
Electroplating composition and process.

Title (de)
Elektroplattierverfahren und Zusammenstellung.

Title (fr)
Procédé et bain d'électrodéposition.

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Application
EP 91310546 A 19911114

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Abstract (en)
An electroplating composition for use in depositing bright zinc-cobalt alloys on a conductive substrate. 2-Naphthaldehyde or a substituted derivative thereof is incorporated in the compositions of the invention as brightening agent.

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